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IN THE SPECIFICATION

Please amend the specification as follows:

Please replace the paragraph beginning on page 2, lines 10-13 with the following:

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Application Serial No. 09/785,892, entitled "METHOD AND APPARATUS FOR PROVIDING POWER TO A MICROPROCESSOR WITH INTEGRATED THERMAL AND EMI MANAGEMENT," by Joseph T. DiBene II, David H. Hartke, James J. Hjerpe Kaskade, and Carl E. Hoge, filed February 16, 2001; and

Please replace the paragraph beginning at page 2, lines 14-17 with the following:

Application Serial No. 09/798,541, entitled "THERMAL/MECHANICAL SPRINGBEAM MECHANISM FOR HEAT TRANSFER FROM HEAT SOURCE TO HEAT DISSIPATING DEVICE," by Joseph T. DiBene II, David H. Hartke, Wendell C. Johnson, and Edward J. Derian, filed March 2, 2001.

Please replace the paragraph beginning at page 2, lines 18-23 with the following:

This patent application is also related to Application Serial No. 09/802,329, entitled "METHOD AND APPARATUS FOR THERMAL AND MECHANICAL MANAGEMENT OF A POWER REGULATOR MODULE AND MICROPROCESSOR IN CONTACT WITH THERMALLY CONDUCTING PLATE," by Joseph T. DiBene II and David H. Hartke, filed on March 8, 2001, which application is hereby incorporated by reference herein.

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